R8C/56E Group

Timer RB2 in Timer Mode

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Abstract

This document describes using timer RB2 in timer mode.

Products

R8C/56E Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

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1. Specifications

Generate a timer RB2_0 interrupt every millisecond using timer RB2 in timer mode.

Table 1.1 lists the Peripheral Function and Its Application and Figure 1.1 shows the Block Diagram.

Table 1.1 Peripheral Function and Its Application

Peripheral Function	Application
Timer RB2	Measure 1 ms.

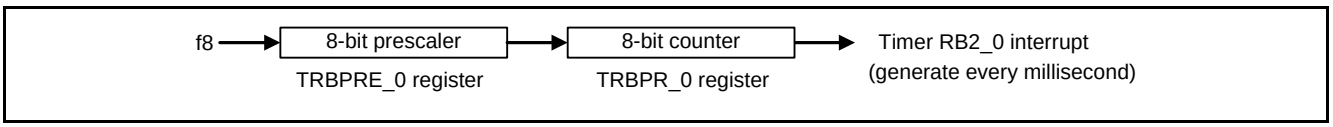

Figure 1.1 Block Diagram

2. Operation Confirmation Conditions

The sample code accompanying this application note has been run and confirmed under the conditions below.

Table 2.1 Operation Confirmation Conditions

Item	Contents
MCU used	R8C/56E Group
Operating frequencies	• XIN clock: 20 MHz • System clock: 20 MHz • CPU clock: 20 MHz
Operating voltage	5.0 V (2.7 to 5.5 V)
Integrated development environment	Renesas Electronics Corporation High-performance Embedded Workshop Version 4.09
C compiler	Renesas Electronics Corporation M16C Series, R8C Family C Complier V.5.45 Release 01
	Compile options -D__UART0__ -c -finfo -dir "$(CONFIGDIR)" -R8C (Default setting is used in the integrated development environment.)

3. Software

3.1 Operation Overview

Use timer RB2 in timer mode to generate a timer RB2_0 interrupt every millisecond and count the number of timer RB2_0 interrupts.

Settings

- Use timer RB2_0
- Use timer mode
- Use f8 for the count source of timer RB2_0
- Use the timer RB2_0 interrupt

Formula for setup time

1 ms = (1 ÷ f8) × (TRB2_0 + 1)

= {1 ÷ (20 MHz ÷ 8)} × 25 × 100

= 400 ns × 2500

Operation

(1) Initial setting
Perform an initial setting of timer RB2_0.

(2) Timer RB2_0 count start
Set the TSTART bit in the TRBCR_0 register to 1 to start the timer RB2_0 count.

(3) Timer RB2_0 interrupt is generated (first to ninth time)
When timer RB2_0 underflows, a timer RB2_0 interrupt is generated and the timer RB2_0 interrupt counter is incremented in the timer RB2_0 interrupt handling.

(4) Timer RB2_0 interrupt is generated (tenth time)
When timer RB2_0 underflows, a timer RB2_0 interrupt is generated and the timer RB2_0 interrupt counter is incremented in the timer RB2_0 interrupt handling. When the timer RB2_0 interrupt counter value is larger than nine, it is initialized.

Figure 3.1 shows the Timing Diagram.

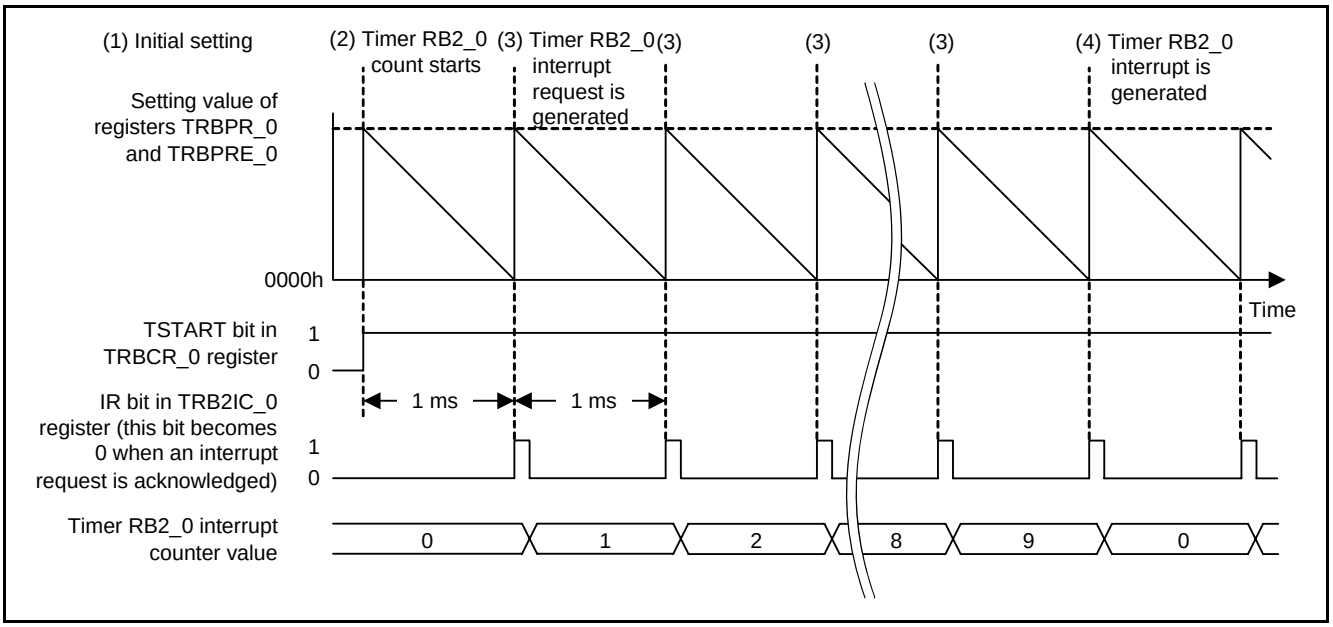

Figure 3.1 Timing Diagram

3.2 Required Memory Size

Table 3.1 lists the Required Memory Size.

Table 3.1 Required Memory Size

Memory Used	Size	Remarks
ROM	142 bytes	In the r01an0970_src.c.module
RAM	1 byte	In the r01an0970_src.c.module
Maximum user stack usage	10 bytes	
Maximum interrupt stack usage	18 bytes	

Note: The required memory size varies depending on the C compiler version and compile options.

3.3 Variable

Table 3.2 lists the Global Variable.

Table 3.2 Global Variable

Type	Variable Name	Contents	Function Used
unsigned char	cnt_tmrb2_int	Timer RB2_0 interrupt counter	timer_rb2_ch0

3.4 Functions

Table 3.3 lists the Functions.

Table 3.3 Functions

Function Name	Outline
mcu_init	System clock setting
timer_rb2_init	Initial setting of timer RB2_0
timer_rb2_ch0	Timer RB2_0 interrupt handling

3.5 Function Specifications

The following tables list the sample code function specifications.

mcu_init	
Outline	System clock setting
Header	None
Declaration	void mcu_init(void)
Description	Set the system clock.
Arguments	None
Returned Value	None

timer_rb2_init	
Outline	Initial setting of timer RB2_0
Header	None
Declaration	void timer_rb2_init(void)
Description	Perform initial setting to use timer RB2_0 in timer mode.
Arguments	None
Returned Value	None

timer_rb2_ch0	
Outline	Timer RB2_0 interrupt handling
Header	None
Declaration	void timer_rb2_ch0(void)
Description	Perform timer RB2_0 interrupt handling.
Arguments	None
Returned Value	None

3.6 Flowcharts

3.6.1 Main Processing

Figure 3.2 shows the Main Processing.

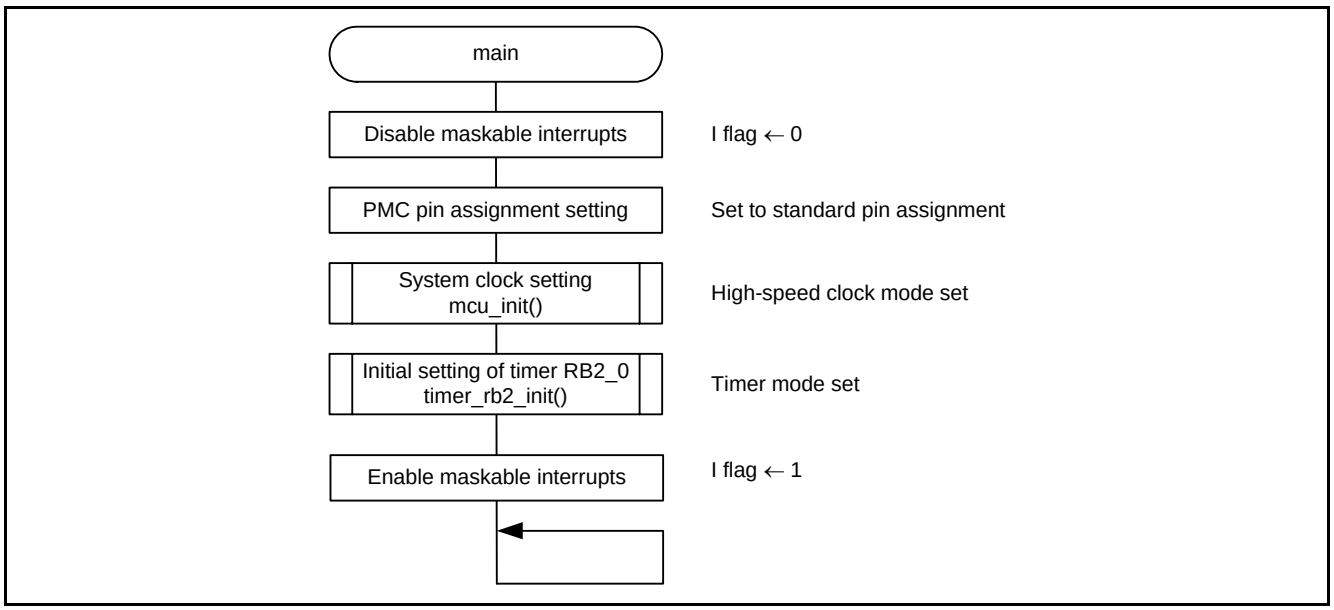

Figure 3.2 Main Processing

3.6.2 System Clock Setting

Figure 3.3 shows the System Clock Setting.

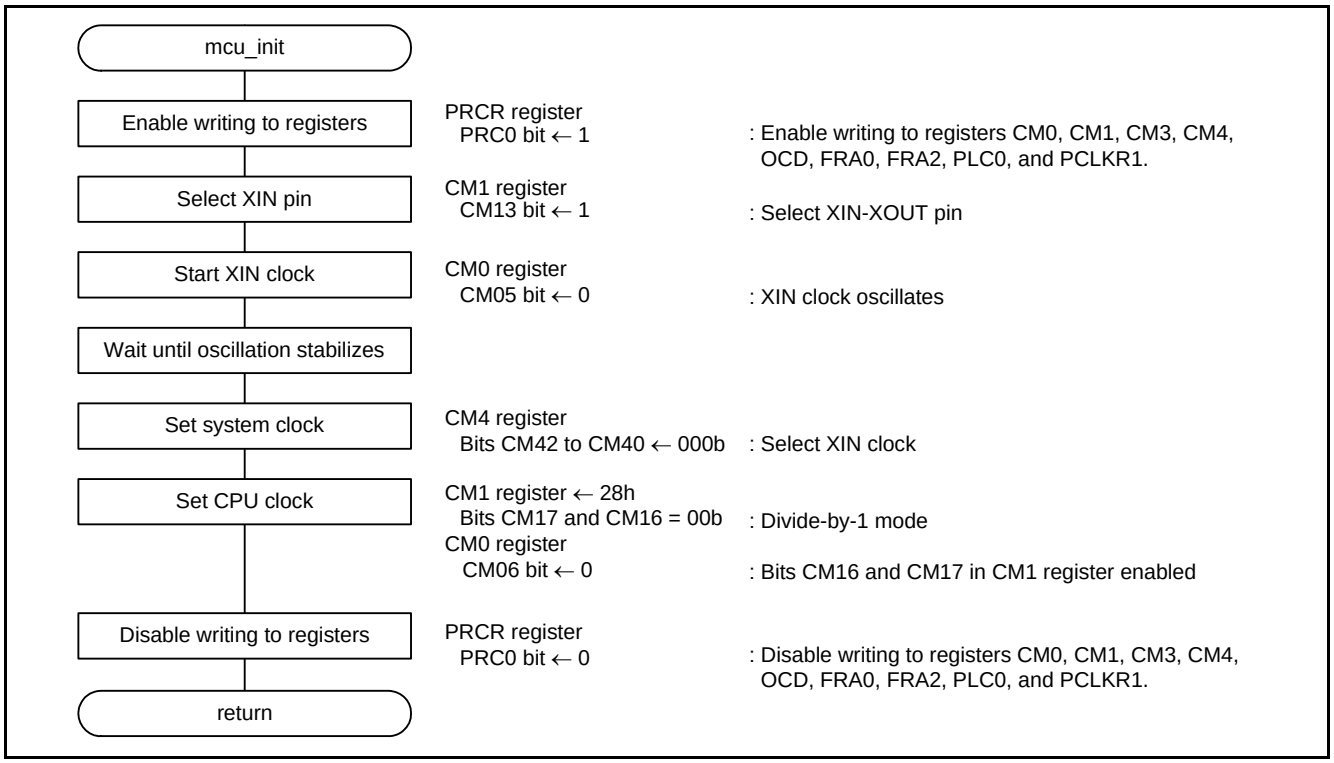

Figure 3.3 System Clock Setting

3.6.3 Initial Setting of Timer RB2_0

Figure 3.4 shows the Initial Setting of Timer RB2_0.

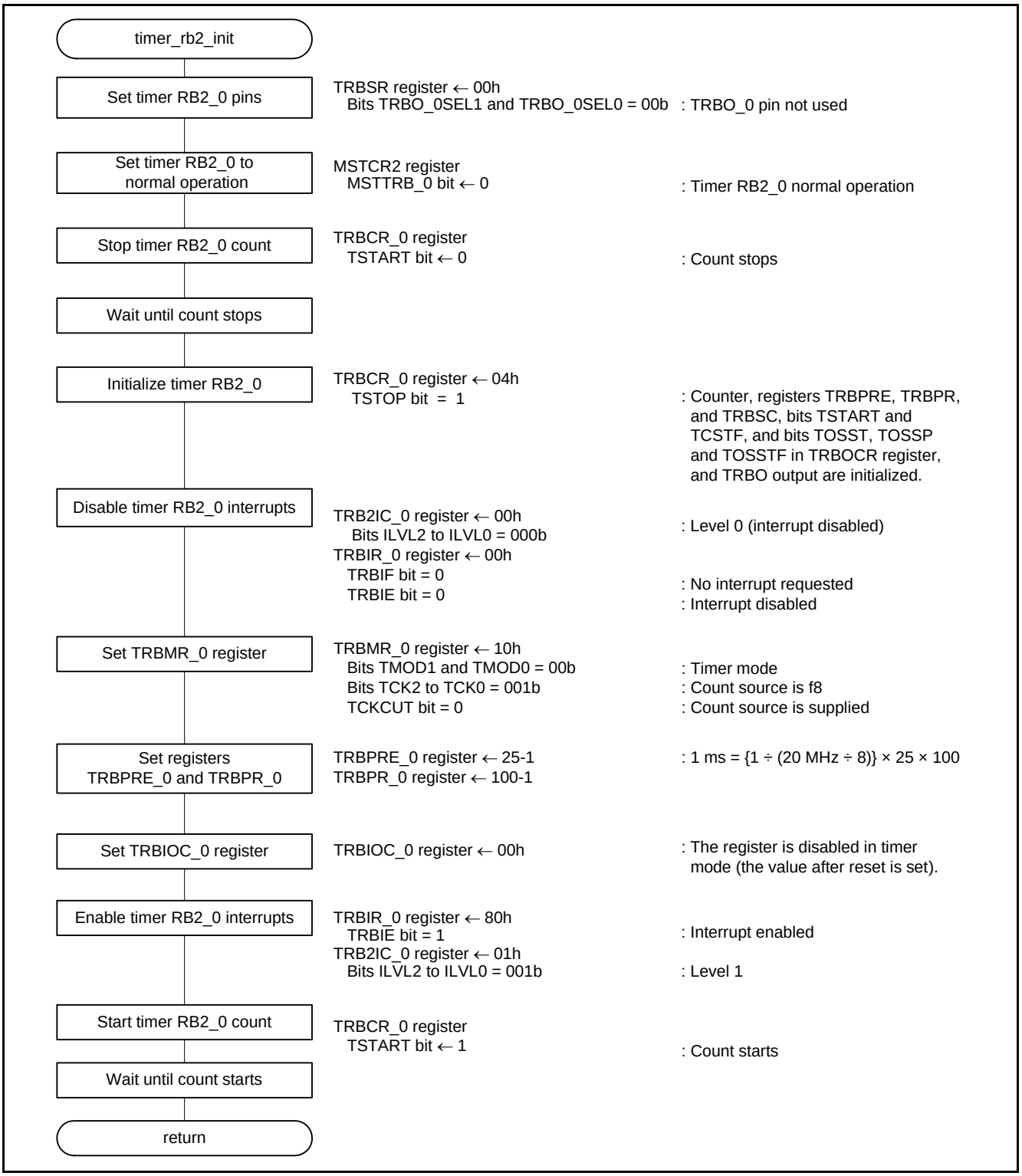

Figure 3.4 Initial Setting of Timer RB2_0

3.6.4 Timer RB2_0 Interrupt Handling

Figure 3.5 shows the Timer RB2_0 Interrupt Handling.

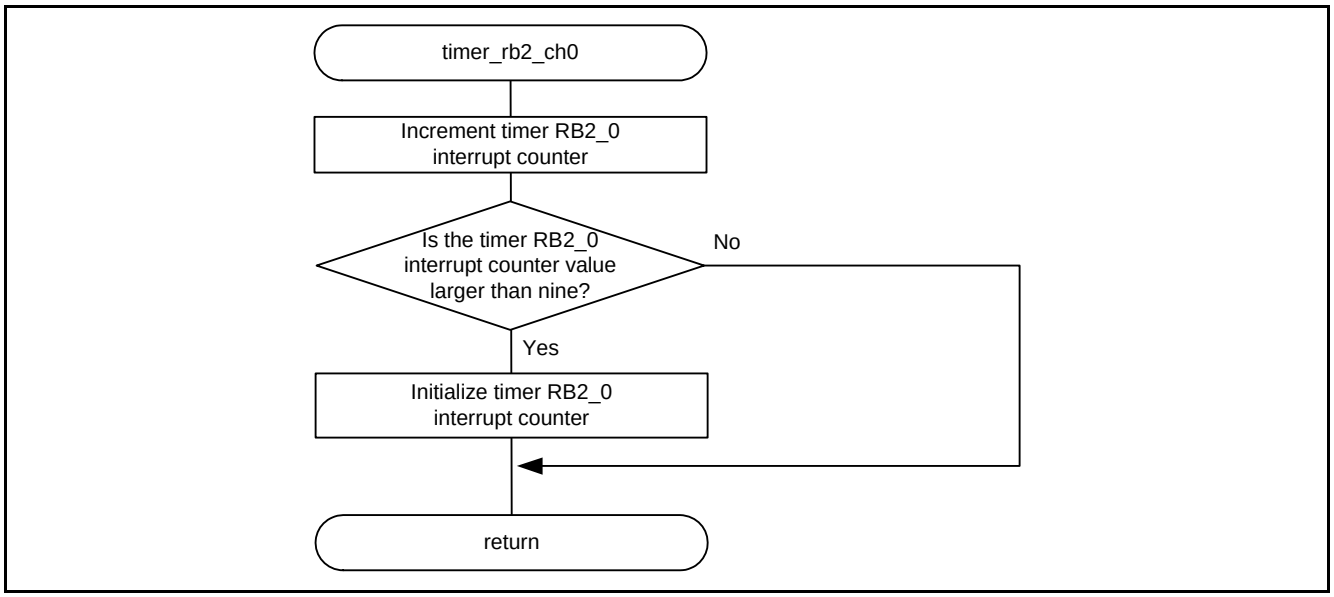

Figure 3.5 Timer RB2_0 Interrupt Handling

4. Sample Code

Sample code can be downloaded from the Renesas Electronics website.

5. Reference Documents

User's Manual: Hardware

R8C/56E Group User's Manual: Hardware Rev.1.00

The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

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REVISION HISTORY	R8C/56E Group Application Note Timer RB2 in Timer Mode

Rev.	Date	Description	
		Page	Summary
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General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins
   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.
   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
2. Processing at Power-on
   The state of the product is undefined at the moment when power is supplied.
   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.
3. Prohibition of Access to Reserved Addresses
   Access to reserved addresses is prohibited.
   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.
4. Clock Signals
   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.
   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
5. Differences between Products
   Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.
   — The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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